

Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)  
 Contact Info: [ti.com/support](http://ti.com/support)  
 Form/Declaration Type: Distribute - RoHS and IEC 62474 DB  
 Created on: 08/26/2022

Details for "CAHCT1G126QDCKRQ1"

**Current Product Information**

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package   Pins	Package body size (mm)	Total device mass (mg)*
CAHCT1G126QDCKRQ1	NIPDAU	Level-1-260C-UNLIM	Ext-Mfg	DCK   5	1.25x2x0.9	7.9

**\*Total Device Mass**

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

**Environmental Ratings Information**

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

**Component Information**

Component	Substance	CAS Number	Amount (mg)	Homogeneous Material Level		Component Level	
				Percentage %	ppm	Percentage %	ppm
<b>Bond Wire</b>							
Not Categorized	Proprietary Materials		0.00001	0.00392	39	0.000013	0
Precious Metals	Gold	7440-57-5	0.025509	99.99608	999961	0.323007	3230
Sub-Total			0.02551	100	1000000	0.323019	3230
<b>Die Attach Adhesive</b>							
Precious Metals	Silver	7440-22-4	0.04274	72.999932	729999	0.541194	5412
Thermoplastics	Epoxy	85954-11-6	0.015808	27.000068	270001	0.200168	2002
Sub-Total			0.058548	100	1000000	0.741362	7414
<b>Lead Frame</b>							
Copper and Its Alloys	Copper	7440-50-8	3.241136	97.04	970400	41.040768	410408
Copper and Its Alloys	Iron	7439-89-6	0.08684	2.6	26000	1.099608	10996
Copper and Its Alloys	Phosphorus	7723-14-0	0.00501	0.15	1500	0.063439	634
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.000334	0.01	100	0.004229	42
Zinc and Its Alloys	Zinc	7440-66-6	0.00668	0.2	2000	0.084585	846
Sub-Total			3.34	100	1000000	42.29263	422926
<b>Lead Frame Plating</b>							
Nickel and Its Alloys	Nickel	7440-02-0	0.057072	95.12	951200	0.722672	7227
Precious Metals	Gold	7440-57-5	0.000468	0.78	7800	0.005926	59
Precious Metals	Palladium	7440-05-3	0.00246	4.1	41000	0.03115	311
Sub-Total			0.06	100	1000000	0.759748	7597
<b>Mold Compound</b>							
Other Inorganic Materials	Fused Silica	60676-86-0	3.563959	84.999999	850000	45.128503	451285
Other Plastics and Rubber	Carbon Black	1333-86-4	0.012579	0.300008	3000	0.159281	1593
Thermoplastics	Epoxy	85954-11-6	0.616355	14.699994	147000	7.804573	78046
Sub-Total			4.192893	100	1000000	53.092357	530924
<b>Semiconductor Device</b>							
Ceramics / Glass	Doped Silicon	7440-21-3	0.220406	100	1000000	2.790883	27909
Sub-Total			0.220406	100	1000000	2.790883	27909
<b>Total</b>			7.897357			100	1000000

**Important Note**

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component. The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component. [See Glossary of Terms for more details.](#)

**Important Part Information**

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMIS or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

**Product Content Methodology**

[For an explanation of the methods used to determine material weights, See Product Content Methodology](#)

**Material Declaration Certificate for Semiconductor IC Packaged Products**

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

**Important Information/Disclaimer**

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is." [For additional information, please contact TI customer support.](#)

Signature: [\(click here for a fuller statement with a signed certificate\)](#)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality  
 For further environmental statements, please go to [www.ti.com/ecoinfo](http://www.ti.com/ecoinfo)  
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**RoHS:** Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

**RoHS Exempt:** Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in <http://www.ti.com/lit/pdf/szzq088>

**Green:** Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide [Sb2O3] contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.